

# DATA SHEET

## **74F174** Hex D flip-flops

Product specification

1988 Oct 07

IC15 Data Handbook

# Hex D flip-flop

# 74F174

## FEATURES

- Six edge-triggered D-type flip-flops
- Buffered common Clock
- Buffered, asynchronous Master Reset

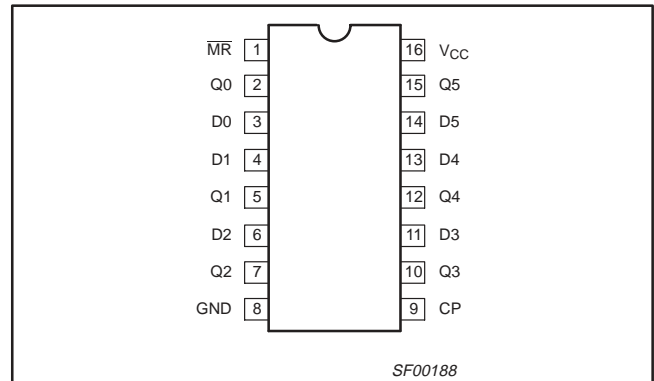
## DESCRIPTION

The 74F174 has six edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset ( $\overline{MR}$ ) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the Low-to-High clock transition is transferred to the corresponding flip-flop's Q output.

All Q outputs will be forced Low independent of Clock or Data inputs by a Low voltage level on the  $\overline{MR}$  input. The device is useful for applications where true outputs only are required, and the Clock and Master Reset are common to all storage elements.

## PIN CONFIGURATION



| TYPE   | TYPICAL $f_{MAX}$ | TYPICAL SUPPLY CURRENT (TOTAL) |
|--------|-------------------|--------------------------------|
| 74F174 | 100MHz            | 35mA                           |

## ORDERING INFORMATION

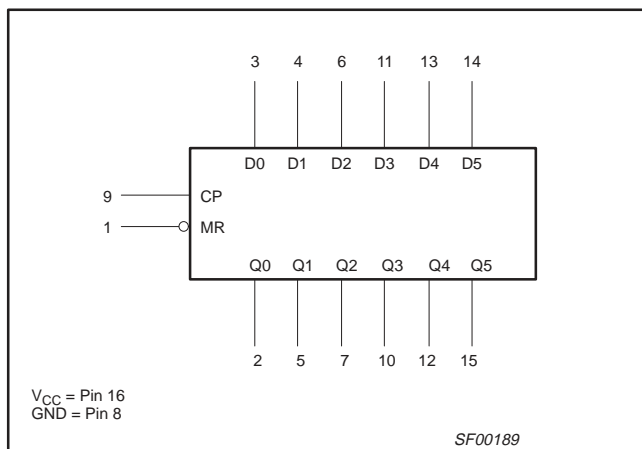
| DESCRIPTION        | COMMERCIAL RANGE<br>$V_{CC} = 5V \pm 10\%$ ,<br>$T_{amb} = 0^{\circ}C$ to $+70^{\circ}C$ | PKG DWG # |
|--------------------|--|-----------|
| 16-pin plastic DIP | N74F174N   | SOT38-4   |
| 16-pin plastic SO  | N74F174D   | SOT109-1  |

## INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

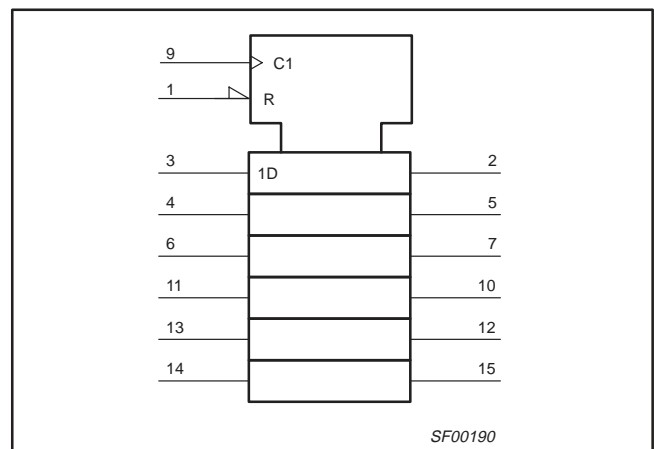
| PINS            | DESCRIPTION                            | 74F (U.L.) HIGH/LOW | LOAD VALUE HIGH/LOW |
|-----------------|--|---------------------|---------------------|
| D0–D5           | Data inputs                            | 1.0/1.0             | 20 $\mu$ A/0.6mA    |
| CP              | Clock Pulse input (active rising edge) | 1.0/1.0             | 20 $\mu$ A/0.6mA    |
| $\overline{MR}$ | Master Reset input (active-Low)        | 1.0/1.0             | 20 $\mu$ A/0.6mA    |
| Q0–Q5           | Outputs                                | 50/33               | 1.0mA/20mA          |

**NOTE:** One (1.0) FAST unit load is defined as: 20 $\mu$ A in the High state and 0.6mA in the Low state.

## LOGIC SYMBOL



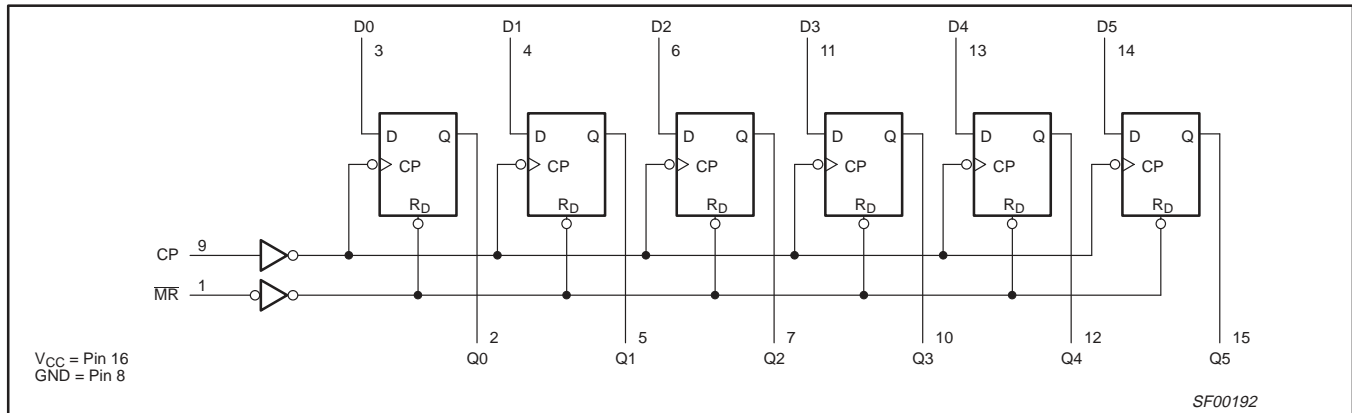
## IEC/IEEE SYMBOL



# Hex D flip-flop

74F174

## LOGIC DIAGRAM



## FUNCTION TABLE

| INPUTS |    |   | OUTPUTS        | OPERATING MODE |
|--------|----|---|----------------|----------------|
| MR     | CP | D | Q <sub>n</sub> |                |
| L      | X  | X | L              | Reset (clear)  |
| H      | ↑  | h | H              | Load "1"       |
| H      | ↑  | l | L              | Load "0"       |

H = High voltage level

L = Low voltage level

X = Don't care

↑ = Low-to-High Clock transition

h = High voltage level one set-up time prior to the Low-to-High Clock transition.

l = Low voltage level one set-up time prior to the Low-to-High Clock transition.

## ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limits set forth in this table may impair the useful life of the device.

Unless otherwise noted these limits are over the operating free-air temperature range.)

| SYMBOL           | PARAMETER                                      | RATING                  | UNIT |
|------------------|--|-------------------------|------|
| V <sub>CC</sub>  | Supply voltage                                 | -0.5 to +7.0            | V    |
| V <sub>IN</sub>  | Input voltage                                  | -0.5 to +7.0            | V    |
| I <sub>IN</sub>  | Input current                                  | -30 to +5               | mA   |
| V <sub>OUT</sub> | Voltage applied to output in High output state | -0.5 to V <sub>CC</sub> | V    |
| I <sub>OUT</sub> | Current applied to output in Low output state  | 40                      | mA   |
| T <sub>amb</sub> | Operating free-air temperature range           | 0 to +70                | °C   |
| T <sub>stg</sub> | Storage temperature range                      | -65 to +150             | °C   |

## RECOMMENDED OPERATING CONDITIONS

| SYMBOL           | PARAMETER                            | LIMITS |     |     | UNIT |
|------------------|--------------------------------------|--------|-----|-----|------|
|                  |                                      | MIN    | NOM | MAX |      |
| V <sub>CC</sub>  | Supply voltage                       | 4.5    | 5.0 | 5.5 | V    |
| V <sub>IH</sub>  | High-level input voltage             | 2.0    |     |     | V    |
| V <sub>IL</sub>  | Low-level input voltage              |        |     | 0.8 | V    |
| I <sub>IK</sub>  | Input clamp current                  |        |     | -18 | mA   |
| I <sub>OH</sub>  | High-level output current            |        |     | -1  | mA   |
| I <sub>OL</sub>  | Low-level output current             |        |     | 20  | mA   |
| T <sub>amb</sub> | Operating free-air temperature range | 0      |     | +70 | °C   |

## Hex D flip-flop

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**DC ELECTRICAL CHARACTERISTICS**

(Over recommended operating free-air temperature range unless otherwise noted.)

| SYMBOL          | PARAMETER                                 | TEST CONDITIONS <sup>1</sup>   | LIMITS              |                  |       | UNIT |    |    |
|-----------------|---|--|---------------------|------------------|-------|------|----|----|
|                 |   |  | MIN                 | TYP <sup>2</sup> | MAX   |      |    |    |
| V <sub>OH</sub> | High-level output voltage                 | V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX                           | ±10%V <sub>CC</sub> | 2.5              |       | V    |    |    |
|                 |   | V <sub>IH</sub> = MIN, I <sub>OH</sub> = MAX                           | ±5%V <sub>CC</sub>  | 2.7              | 3.4   |      |    |    |
| V <sub>OL</sub> | Low-level output voltage                  | V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX                           | ±10%V <sub>CC</sub> |                  | 0.30  | 0.50 | V  |    |
|                 |   | V <sub>IH</sub> = MIN, I <sub>OL</sub> = MAX                           | ±5%V <sub>CC</sub>  |                  | 0.30  | 0.50 |    |    |
| V <sub>IK</sub> | Input clamp voltage                       | V <sub>CC</sub> = MIN, I <sub>I</sub> = I <sub>IK</sub>                |                     |                  | -0.73 | -1.2 | V  |    |
| I <sub>I</sub>  | Input current at maximum input voltage    | V <sub>CC</sub> = MAX, V <sub>I</sub> = 7.0V                           |                     |                  |       | 100  | μA |    |
| I <sub>IH</sub> | High-level input current                  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7V                           |                     |                  |       | 20   | μA |    |
| I <sub>IL</sub> | Low-level input current                   | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5V                           |                     |                  |       | -0.6 | mA |    |
| I <sub>OS</sub> | Short-circuit output current <sup>3</sup> | V <sub>CC</sub> = MAX  |                     |                  |       | -60  | mA |    |
| I <sub>CC</sub> | Supply current (total)                    | V <sub>CC</sub> = MAX, D <sub>n</sub> = $\overline{MR}$ = 4.5V, CP = ↑ |                     |                  |       | 35   | 45 | mA |

**NOTES:**

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
- All typical values are at V<sub>CC</sub> = 5V, T<sub>amb</sub> = 25°C.
- Not more than one output should be shorted at a time. For testing I<sub>OS</sub>, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

**AC ELECTRICAL CHARACTERISTICS**

| SYMBOL                               | PARAMETER   | TEST CONDITION | LIMITS  |            |             |  |             | UNIT |
|--------------------------------------|---|----------------|---|------------|-------------|--|-------------|------|
|                                      |   |                | V <sub>CC</sub> = +5.0V<br>T <sub>amb</sub> = +25°C<br>C <sub>L</sub> = 50pF, R <sub>L</sub> = 500Ω |            |             | V <sub>CC</sub> = +5.0V ± 10%<br>T <sub>amb</sub> = 0°C to +70°C<br>C <sub>L</sub> = 50pF, R <sub>L</sub> = 500Ω |             |      |
|                                      |   |                | MIN   | TYP        | MAX         | MIN  | MAX         |      |
| f <sub>MAX</sub>                     | Maximum clock frequency                             | Waveform 1     | 80  | 100        |             | 80   |             | MHz  |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation delay<br>CP to Q <sub>n</sub>           | Waveform 1     | 3.5<br>4.5  | 5.5<br>6.0 | 8.0<br>10.0 | 3.5<br>4.5   | 9.0<br>11.0 | ns   |
| t <sub>PHL</sub>                     | Propagation delay $\overline{MR}$ to Q <sub>n</sub> | Waveform 2     | 5.0   | 8.5        | 14.0        | 5.0  | 15.0        | ns   |

**AC SETUP REQUIREMENTS**

| SYMBOL                                   | PARAMETER                                       | TEST CONDITION | LIMITS  |     |     |  |     | UNIT |
|--|---|----------------|---|-----|-----|--|-----|------|
|  |   |                | V <sub>CC</sub> = +5.0V<br>T <sub>amb</sub> = +25°C<br>C <sub>L</sub> = 50pF, R <sub>L</sub> = 500Ω |     |     | V <sub>CC</sub> = +5.0V ± 10%<br>T <sub>amb</sub> = 0°C to +70°C<br>C <sub>L</sub> = 50pF, R <sub>L</sub> = 500Ω |     |      |
|  |   |                | MIN   | TYP | MAX | MIN  | MAX |      |
| t <sub>S</sub> (H)<br>t <sub>S</sub> (L) | Setup time, High or Low<br>D <sub>n</sub> to CP | Waveform 3     | 4.0<br>4.0  |     |     | 4.0<br>4.0   |     | ns   |
| t <sub>H</sub> (H)<br>t <sub>H</sub> (L) | Hold time, High or Low<br>D <sub>n</sub> to CP  | Waveform 3     | 0.0<br>0.0  |     |     | 0.0<br>0.0   |     | ns   |
| t <sub>w</sub> (H)<br>t <sub>w</sub> (L) | CP Pulse width,<br>High or Low                  | Waveform 1     | 4.0<br>6.0  |     |     | 4.0<br>6.0   |     | ns   |
| t <sub>w</sub> (L)                       | $\overline{MR}$ Pulse width, Low                | Waveform 2     | 5.0   |     |     | 5.0  |     | ns   |
| t <sub>REC</sub>                         | Recovery time, $\overline{MR}$ to CP            | Waveform 2     | 5.0   |     |     | 5.0  |     | ns   |

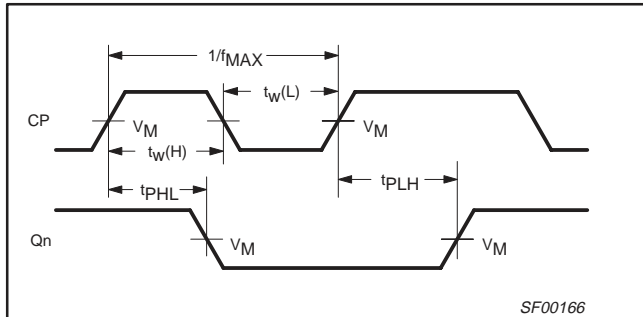
# Hex D flip-flop

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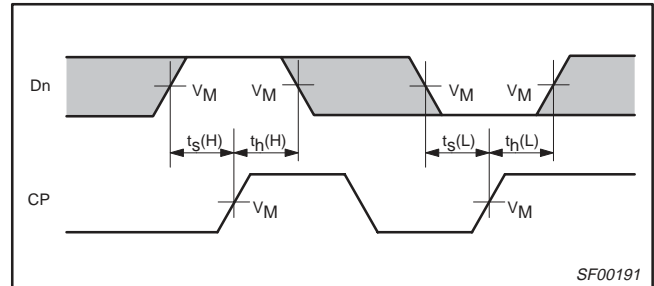
## AC WAVEFORMS

For all waveforms,  $V_M = 1.5V$ .

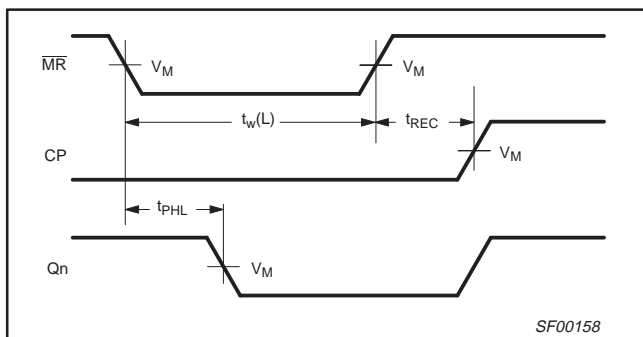
The shaded areas indicate when the input is permitted to change for predictable output performance.



**Waveform 1. Propagation Delay, Clock Input to Output, Clock Pulse Width, and Maximum Clock Frequency**

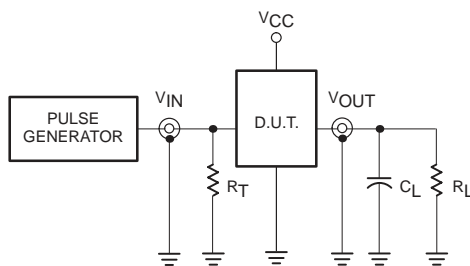


**Waveform 3. Data Setup and Hold Times**

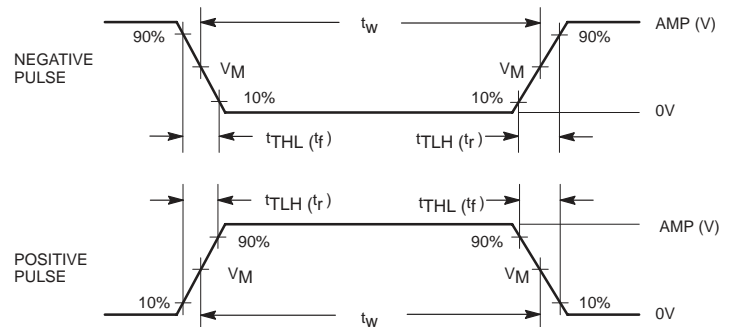


**Waveform 2. Master Reset Pulse Width, Master Reset to Output Delay and Master Reset to Clock recovery Time**

## TEST CIRCUIT AND WAVEFORMS



**Test Circuit for Totem-Pole Outputs**



**Input Pulse Definition**

### DEFINITIONS:

- $R_L$  = Load resistor; see AC ELECTRICAL CHARACTERISTICS for value.
- $C_L$  = Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.
- $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

| family | INPUT PULSE REQUIREMENTS |       |           |       |                     |                     |
|--------|--------------------------|-------|-----------|-------|---------------------|---------------------|
|        | amplitude                | $V_M$ | rep. rate | $t_w$ | $t_{TLH}$ ( $t_r$ ) | $t_{THL}$ ( $t_f$ ) |
| 74F    | 3.0V                     | 1.5V  | 1MHz      | 500ns | 2.5ns               | 2.5ns               |

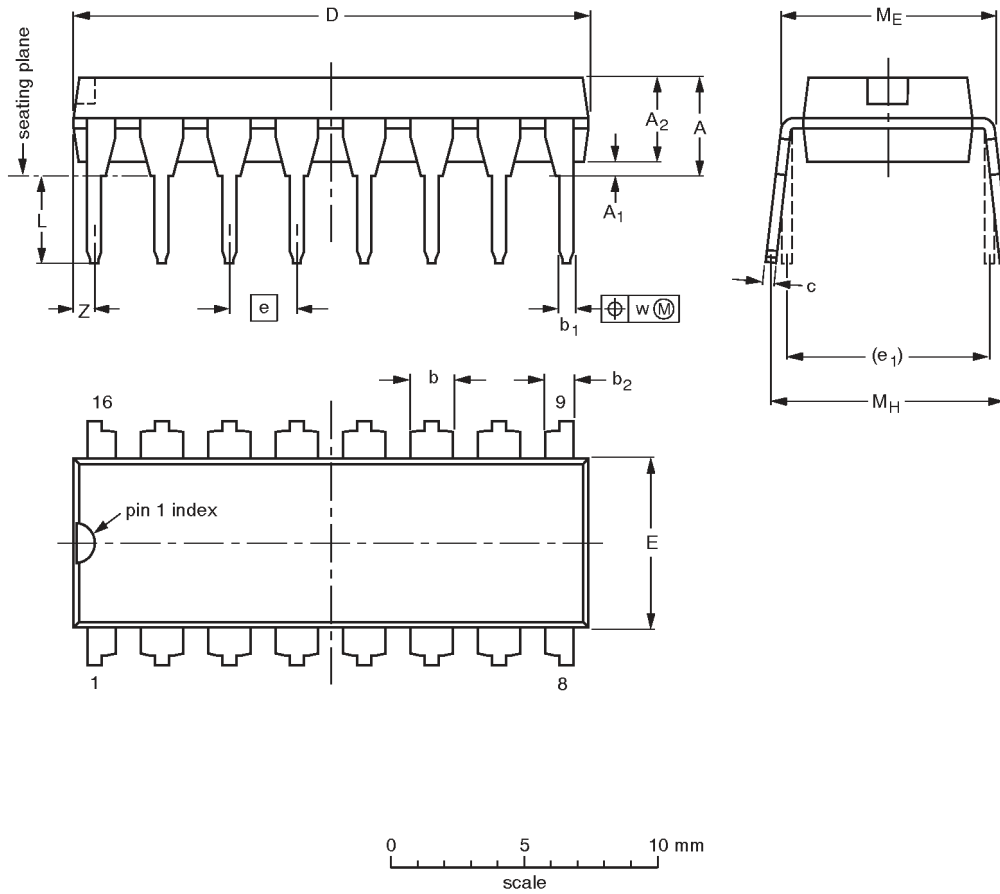
SF00006

# Hex D flip-flops

74F174

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



**DIMENSIONS** (inch dimensions are derived from the original mm dimensions)

| UNIT   | A max. | A <sub>1</sub> min. | A <sub>2</sub> max. | b              | b <sub>1</sub> | b <sub>2</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | e <sub>1</sub> | L            | M <sub>E</sub> | M <sub>H</sub> | w     | Z <sup>(1)</sup> max. |
|--------|--------|---------------------|---------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|-----------------------|
| mm     | 4.2    | 0.51                | 3.2                 | 1.73<br>1.30   | 0.53<br>0.38   | 1.25<br>0.85   | 0.36<br>0.23   | 19.50<br>18.55   | 6.48<br>6.20     | 2.54 | 7.62           | 3.60<br>3.05 | 8.25<br>7.80   | 10.0<br>8.3    | 0.254 | 0.76                  |
| inches | 0.17   | 0.020               | 0.13                | 0.068<br>0.051 | 0.021<br>0.015 | 0.049<br>0.033 | 0.014<br>0.009 | 0.77<br>0.73     | 0.26<br>0.24     | 0.10 | 0.30           | 0.14<br>0.12 | 0.32<br>0.31   | 0.39<br>0.33   | 0.01  | 0.030                 |

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

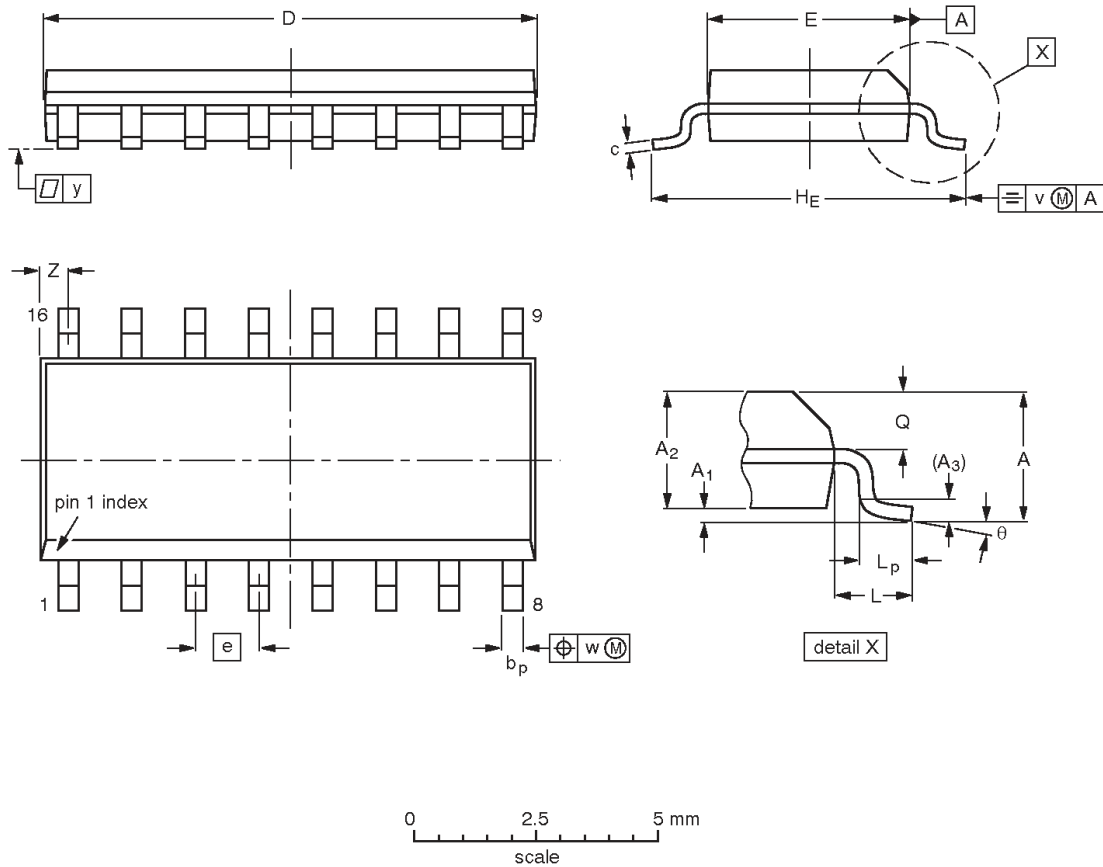
| OUTLINE VERSION | REFERENCES |       |      |  | EUROPEAN PROJECTION | ISSUE DATE            |
|-----------------|------------|-------|------|--|---------------------|-----------------------|
|                 | IEC        | JEDEC | EIAJ |  |                     |                       |
| SOT38-4         |            |       |      |  |                     | -92-11-17<br>95-01-14 |

# Hex D flip-flops

# 74F174

**SO16: plastic small outline package; 16 leads; body width 3.9 mm**

**SOT109-1**



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

| UNIT   | A max. | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c                | D <sup>(1)</sup> | E <sup>(1)</sup> | e     | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | $\theta$ |
|--------|--------|----------------|----------------|----------------|----------------|------------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 1.75   | 0.25<br>0.10   | 1.45<br>1.25   | 0.25           | 0.49<br>0.36   | 0.25<br>0.19     | 10.0<br>9.8      | 4.0<br>3.8       | 1.27  | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8°<br>0° |
| inches | 0.069  | 0.010<br>0.004 | 0.057<br>0.049 | 0.01           | 0.019<br>0.014 | 0.0100<br>0.0075 | 0.39<br>0.38     | 0.16<br>0.15     | 0.050 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.020 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   |          |

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES |          |      |  | EUROPEAN PROJECTION | ISSUE DATE           |
|-----------------|------------|----------|------|--|---------------------|----------------------|
|                 | IEC        | JEDEC    | EIAJ |  |                     |                      |
| SOT109-1        | 076E07S    | MS-012AC |      |  |                     | 95-01-23<br>97-05-22 |

## Hex D flip-flops

74F174

## Data sheet status

| Data sheet status         | Product status | Definition [1]   |
|---------------------------|----------------|--|
| Objective specification   | Development    | This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.  |
| Preliminary specification | Qualification  | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
| Product specification     | Production     | This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.   |

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

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Philips Semiconductors  
811 East Arques Avenue  
P.O. Box 3409  
Sunnyvale, California 94088-3409  
Telephone 800-234-7381

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